

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT5905016

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HIDEAKI TANAKA	02/26/2016
<b>RECEIVING PARTY DATA</b>	
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<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16739511
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<b>ATTORNEY DOCKET NUMBER:</b>	101716.000217
<b>NAME OF SUBMITTER:</b>	BARTH ZURKAMMER
<b>SIGNATURE:</b>	/Barth Zurkammer/
<b>DATE SIGNED:</b>	01/10/2020
<b>Total Attachments: 2</b>	
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source=2020 01 10 101716.000217 GEB4008-US-D1 Assignment-Parent#page2.tif	

**ASSIGNMENT**

WHEREAS, I, Hideaki TANAKA, a citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number (“the invention”), which is entitled “SUBSTRATE CLEANING APPARATUS, SUBSTRATE CLEANING METHOD, AND SUBSTRATE PROCESSING APPARATUS” (“the subject application”), and which claims priorities to Japanese patent application number 2015-029666 filed February 18, 2015 and Japanese patent application number 2015-046292 filed March 9, 2015 (“the priority application”). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors’ certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming

DOCKET NO.: 101716.000129

the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.

Executed this 26th day of February, year of 2016.

Hideaki Tanaka  
Signature (Hideaki TANAKA)

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**STATEMENT OF WITNESS**

SIGNED at \_\_\_\_\_

(City) \_\_\_\_\_ (Country) \_\_\_\_\_

This \_\_\_\_\_ day of \_\_\_\_\_, 201\_\_.

I, \_\_\_\_\_ whose full residence address is \_\_\_\_\_

was personally present and did see \_\_\_\_\_ execute the above assignment on the \_\_\_\_\_ day of \_\_\_\_\_, 201\_\_, and such assignor is personally known to me to be the person described in such document.

\_\_\_\_\_  
Signature of Witness

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The foregoing assignment covers patent application number 15/045,045, filed on February 16, 2016.

/Michael J. Swope/  
Name of Attorney:  
Registration No.: 38,041  
Date of Insertion: March 2, 2016